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SPECIFICATION

(Reference sheet)

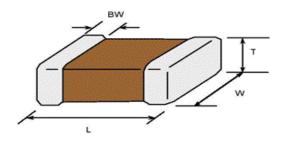
· Supplier : Samsung electro-mechanics · Samsung P/N : CL05X106MR5NUNC

· Product : Multi-layer Ceramic Capacitor · Description : CAP, 10 4, ±20%, X6S, 0402

A. Samsung Part Number

1	Series	Samsung Multi-layer Ceramic Capacitor			
2	Size	0402 (inch code)	L: 1.00 ± 0.20 mm	W: $0.50 \pm 0.20 \text{ mm}$	
3	Dielectric	X6S	8 Inner electrode	Ni	
4	Capacitance	10 <i>#</i> F	Termination	Cu	
(5)	Capacitance	±20 %	Plating	Sn 100% (Pb Free)	
	tolerance		9 Product	Size control code	
6	Rated Voltage	4 V	⑩ Special	Reserved for future use	
7	Thickness	$0.50 \pm 0.20 \text{ mm}$	① Packaging	Cardboard Type, 7" reel	

B. Structure & Dimension



Samsung P/N	Dimension(mm)			
Samsung F/N	L	W	Т	BW
CL05X106MR5NUNC	1.00 ± 0.20	0.50 ± 0.20	0.50 ± 0.20	0.25 ± 0.10

C. Samsung Reliablility Test and Judgement Condition

	Judgement	Test condition		
Capacitance	Within specified tolerance	1 kHz ±10% / 0.5±0.1Vrms		
Tan δ (DF)	0.1 max.	*A capacitor prior to measuring the capacitance is heat treated at $150^{\circ}+0/-10^{\circ}$ for 1hour and maintained in ambient air for 24±2 hours.		
Insulation	10,000Mohm or 100Mohm×µF	Rated Voltage 60~120 sec		
Resistance Whichever is smaller				
Appearance	No abnormal exterior appearance	Microscope (×10)		
Withstanding	No dielectric breakdown or	250% of the rated voltage		
Voltage	mechanical breakdown			
Temperature	X6S			
Characteristics	(From -55℃ to 105℃, Capacitance change should be within ±22%)			
Adhesive Strength	No peeling shall be occur on the	500g·f, for 10±1 sec.		
of Termination	terminal electrode			
Bending Strength	Capacitance change : within ±12.5%	Bending to the limit (1 ^{mm}) with 1.0mm/sec.		
Solderability	More than 75% of terminal surface	SnAg3.0Cu0.5 solder		
	is to be soldered newly	245±5°C, 3±0.3sec.		
		(preheating : 80~120°C for 10~30sec.)		
Resistance to	Capacitance change : within ±7.5%	Solder pot : 270±5°C, 10±1sec.		
Soldering Heat	Tan δ, IR : initial spec.			
Vibration Test	Capacitance change : within ± 10%	Amplitude : 1.5mm		
	Tan δ, IR : initial spec.	From 10Hz to 55Hz (return : 1min.)		
		2hours × 3 direction (x, y, z)		
Moisture	Capacitance change: within ±12.5%	With rated voltage		
Resistance	Tan δ : 0.125 max	40±2°C, 90~95%RH, 500+12/-0hrs		
	IR: 500Mohm or 12.5Mohm × μ F			
	Whichever is smaller			
High Temperature	Capacitance change : within ±12.5%	With 100% of the rated voltage		
Resistance	Tan δ: 0.125 max	Max. operating temperature		
	IR : 1,000Mohm or 25Mohm × μ F	1,000+48/-0hrs		
	Whichever is smaller			
Temperature	Capacitance change: within ±15%	1 cycle condition		
Cycling	Tan δ, IR : initial spec.	Min. operating temperature → 25°C		
		→ Max. operating temperature → 25°C		
		5 cycle test		

X The reliability test condition can be replaced by the corresponding accelerated test condition.

D. Recommended Soldering method:

Reflow (Reflow Peak Temperature : 260±5 °C, 30sec)



Product specifications included in the specifications are effective as of March 1, 2013.

Please be advised that they are standard product specifications for reference only.

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